

描述 / Descriptions

SOT-23 塑封封装 硅半导体二极管。

Silicon Diode in a SOT-23 Plastic Package.

特征 / Features

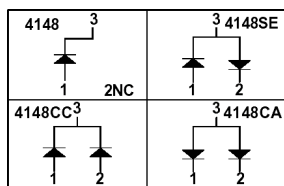
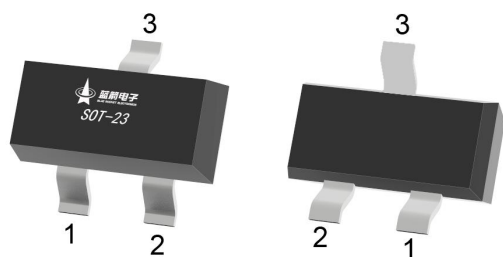
开关速度快，高导电率，符合 AEC-Q101 标准高可靠性要求，无卤产品。

Fast Switching, High Conductance, Qualified to AEC-Q101 Standards for High Reliability, HF Product.

用途 / Applications

用于小信号处理，满足汽车应用的严格要求。

Small signal diode, Meet the stringent requirements of automotive applications.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning**

PIN: See Equivalent Circuit.

印章代码 / Marking

Type	BRMMBD4148Q	BRMMBD4148SEQ	BRMMBD4148CCQ	BRMMBD4148CAQ
Marking	Q5H	QD4	QD5	QD6

极限参数 / Absolute Maximum Ratings(Ta=25°C)

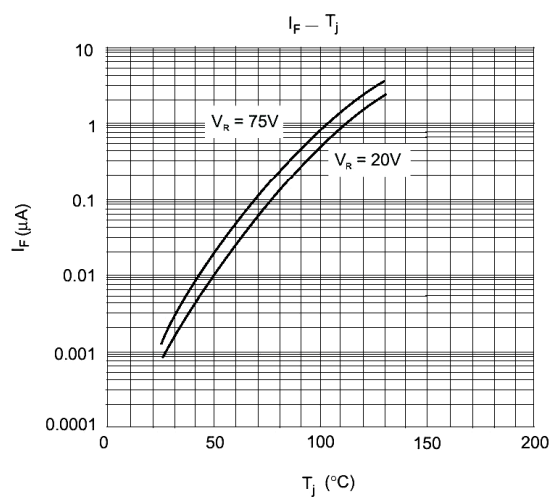
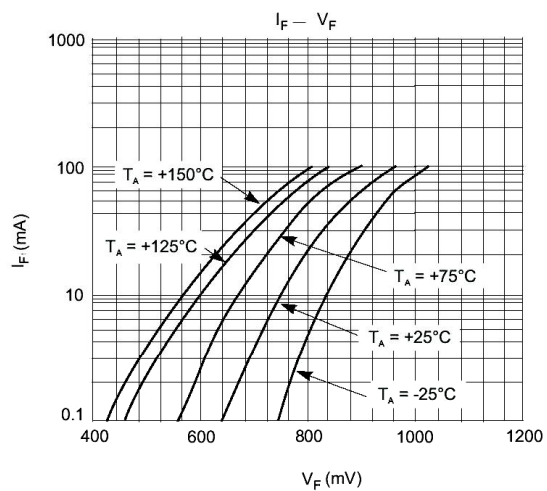
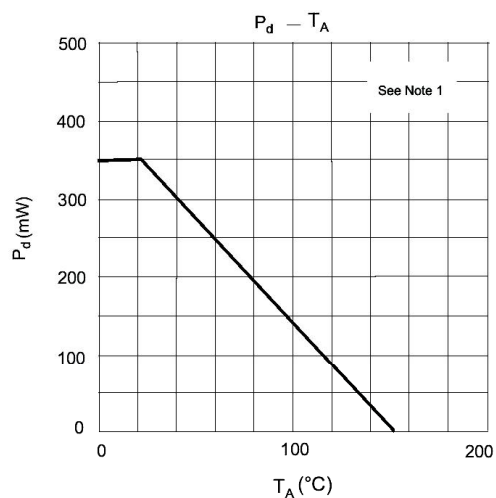
参数 Parameter	符号 Symbol	数值 Rating	单位 Unit
Repetitive Reverse Voltage	V_{RRM}	100	V
Average Rectified Forward Current	$I_{F(AV)}$	200	mA
Non-repetitive Peak Forward Surge Current	$I_{FSM}(PW=1.0S)$	1.0	A
Non-repetitive Peak Forward Surge Current	$I_{FSM}(PW=1.0\mu S)$	2.0	A
Power Dissipation	PC	350	mW
Thermal Resistance, Junction to Ambient	$R_{\theta JA}$	357	°C/W
Junction Temperature	T_j	150	°C
Storage Temperature Range	T_{stg}	-55~150	°C

电性能参数 / Electrical Characteristics(Ta=25°C)

参数 Parameter	符号 Symbol	测试条件 Test Conditions	最小值 Min	典型值 Typ	最大值 Max	单位 Unit
Breakdown Voltage	V_R	$I_R=5.0\mu A$	75			V
		$I_R=100\mu A$	100			V
Forward Voltage	V_F	$I_F=10mA$			1.0	V
Instantaneous Reverse Current	I_R	$V_R=20V$			25	nA
		$V_R=20V \quad T_A=150^\circ C$			50	μA
		$V_R=75V$			5.0	μA
Total Capacitance	C_T	$V_R=0 \quad f=1.0MHz$			4.0	pF
Reverse Recovery Time	t_{rr}	$I_F=10mA \quad V_R=6.0V$ $I_{RR}=1.0mA \quad R_L=100\Omega$			4.0	ns



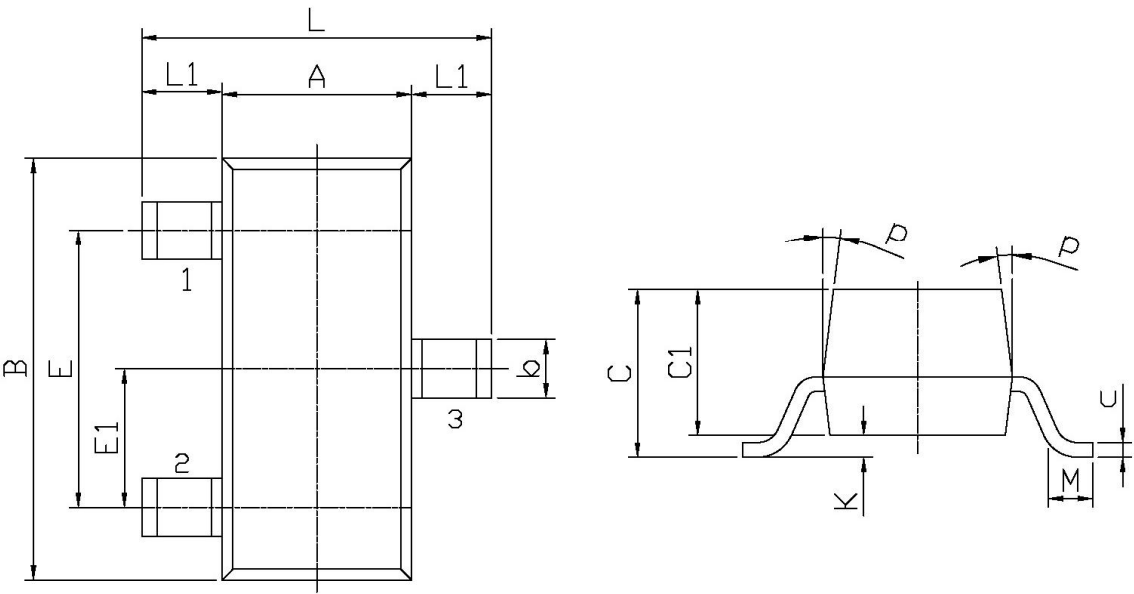
电参数曲线图 / Electrical Characteristic Curve



外形尺寸图 / Package Dimensions

SOT-23

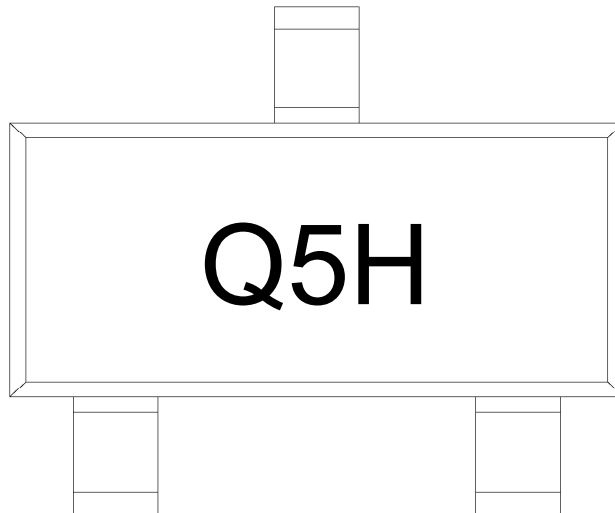
单位：mm



Symbol	Dimensions In Millimeters		Symbol	Dimensions In Millimeters	
	Min	Max		Min	Max
L	2.2	2.7	C	1.30Max	
L1	0.45	0.65	C1	0.90	1.20
A	1.15	1.50	c	0.05	0.20
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	P	7°	
b	0.35	0.55			



印章说明 / Marking Instructions



说明：

Q： 为汽车无卤产品标识

5H： 为型号代码

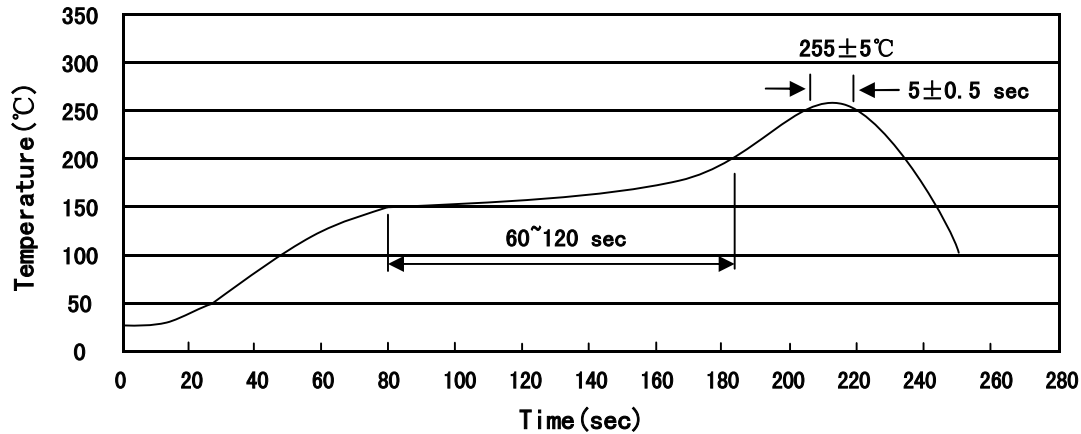
Note:

Q: Automobile halogen-free product Code

5H: Product Type



回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)



说明：

- 1、预热温度 150 ~ 200°C，时间 60 ~ 120sec;
- 2、峰值温度 255±5°C，时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:150~200°C, Time:60~120sec.
- 2.Peak Temp.:255±5°C, Duration:5±0.5sec.
3. Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度：260±5°C

时间：10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.

卷盘包装 / REEL

Package Type 封装形式	Units 包装数量					Dimension 包装尺寸 (unit: mm ³)		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	6	180,000	7" ×8	180×120×180	390×385×205

使用说明 / Notices